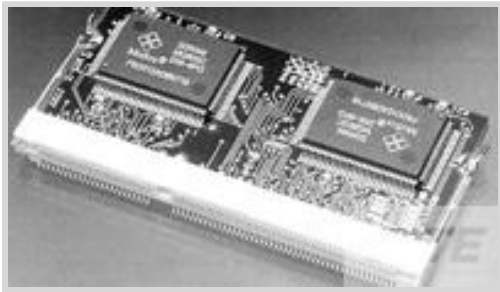




Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR3 SO DIMM Sockets



DRAM Type: **Small Outline (SO)**
Stack Height: **5.2 mm [.205 in]**
Module Orientation: **Right Angle**
Number of Positions: **144**
Centerline (Pitch): **.8 mm [.031 in]**

[All DDR3 SO DIMM Sockets \(12\)](#)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Cable-to-Board
DRAM Type	Small Outline (SO)

Configuration Features

Number of Bays	2
Number of Keys	1
Number of Rows	2
Module Orientation	Right Angle
Number of Positions	144

Electrical Characteristics

DRAM Voltage	3.3 V
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Body Features

Latch Plating Material	Tin
Latch Material	Stainless Steel
Module Key Type	SDRAM
Ejector Location	None
Connector Profile	Standard



Contact Features

Memory Socket Type	Memory Card
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Gold Flash
Contact Mating Area Plating Material	Gold (Au)
Contact Mating Area Plating Material Thickness	.25 µm[9.84 µin]

Termination Features

Insertion Style	Cam-In
Termination Method to PCB	Surface Mount

Mechanical Attachment

Connector Mounting Type	Board Mount
PCB Mount Retention Type	Hold-Down Post
Mating Alignment Type	Offset Left
PCB Mount Retention	With

Housing Features

Housing Material	High Temperature Plastic
Housing Color	Natural
Centerline (Pitch)	.8 mm[.031 in]

Dimensions

Stack Height	5.2 mm[.205 in]
Row-to-Row Spacing	6.2 mm[.244 in]

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	200
Packaging Method	Tape & Reel



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) ‘Guidance on requirements for substances in articles’ posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

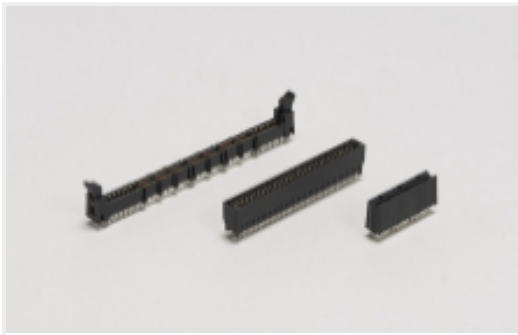
Compatible Parts



Also in the Series | AMP-METRIMATE



Board-to-Board Headers & Receptacles(1)



Card Edge Power Connectors(1)



Connector Hardware(1)



PCB Headers & Receptacles(1)



Rack & Panel Connectors(1)

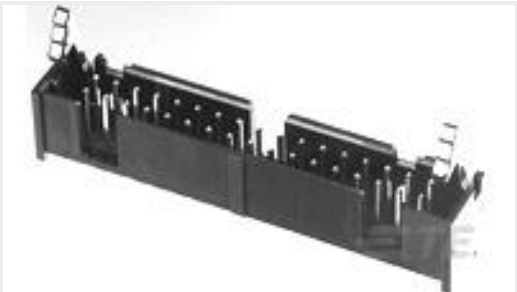


Rectangular Power Connectors(3)

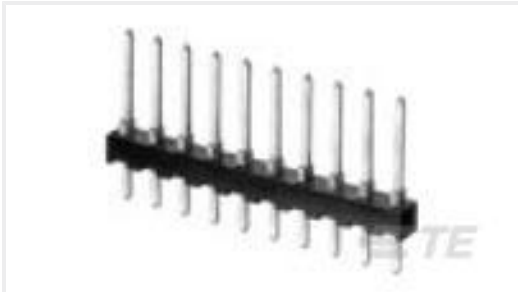


SO DIMM Sockets(12)

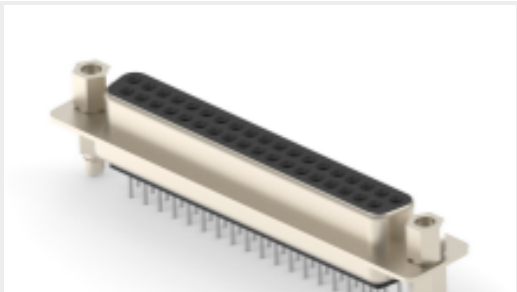
Customers Also Bought



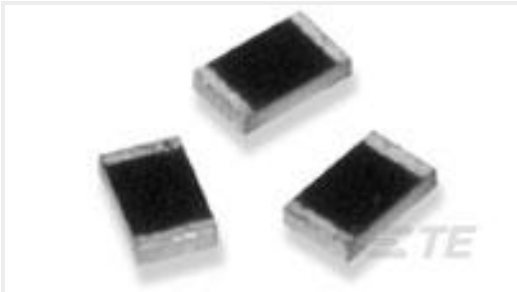
TE Part #2-1761606-8
IDC LOW PRO HDR 24P VERT LA



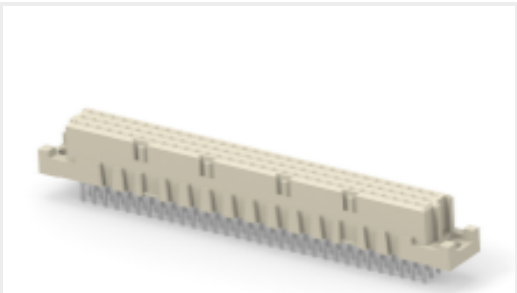
TE Part #825440-8
OD 2 PINHDR 2X08P.



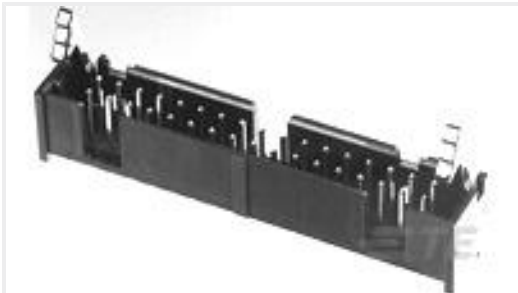
TE Part #2301842-1
AMPL REC HD20, VERT,37P, B/L,4-40 S /LOC



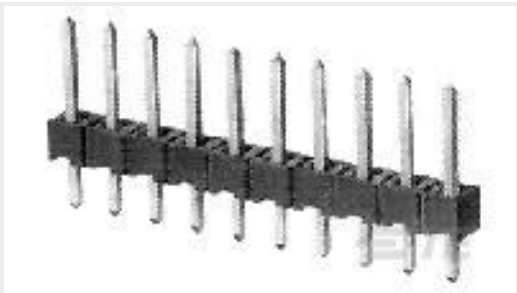
TE Part #8-1879744-6
RP 1J 392R 0.1% 15PPM CUT LENGTH



TE Part #254015-E
STVC 96 F ABC VV 7-00 EE 5,5 * 137 E007



TE Part #3-1761606-5
IDC LOW PRO HDR 50P VERT LA



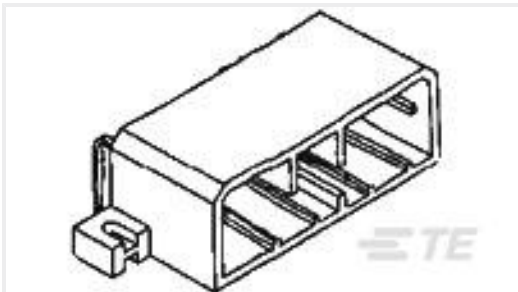
TE Part #1-825433-2
MOD 2 PINHDR 1X12P.



TE Part #354187-E
MSPEED 50 M SMD M10 B AB VV 137 094 **



TE Part #354180-E
MSPEED 50 F SMD F10 B AB VV 137 094 **



TE Part #174467-1
070 MULTILOCK 10P ASSY SGL ROW

Documents



Product Drawings

SKT,SODIMM,144P,SDRAM3.3V,STD,T&R

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_6-390113-1_H.2d_dxf.zip

English

Customer View Model

ENG_CVM_6-390113-1_H.3d_igs.zip

English

Customer View Model

ENG_CVM_6-390113-1_H.3d_stp.zip

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

Product Specification

English

Socket, 144 Position Surface Mount 8 Byte SO DIMM

English